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Okazaki et al.(10) **Pub. No.: US 2009/0244422 A1**(43) **Pub. Date: Oct. 1, 2009**(54) **LIQUID CRYSTAL DISPLAY DEVICE****Publication Classification**(75) Inventors: **Kengo Okazaki**, Mobara (JP);
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(57) **ABSTRACT**

Disclosed is a liquid crystal display device that is capable of preventing a conductive paste for connecting a common wiring line of a TFT substrate and a counter electrode of a counter substrate from flowing outward. A sealant is formed outside a display region of a liquid crystal display device. A conductive paste for connecting a common wiring line of a TFT substrate and a counter electrode of a counter substrate is provided at a corner of the liquid crystal display device outside the sealant. An L-shaped stopper is formed on the counter substrate so as to prevent the conductive paste from flowing outward. With the stopper, even if the width of a frame is equal to or less than 1.5 mm, it is possible to prevent the conductive paste from flowing outward.

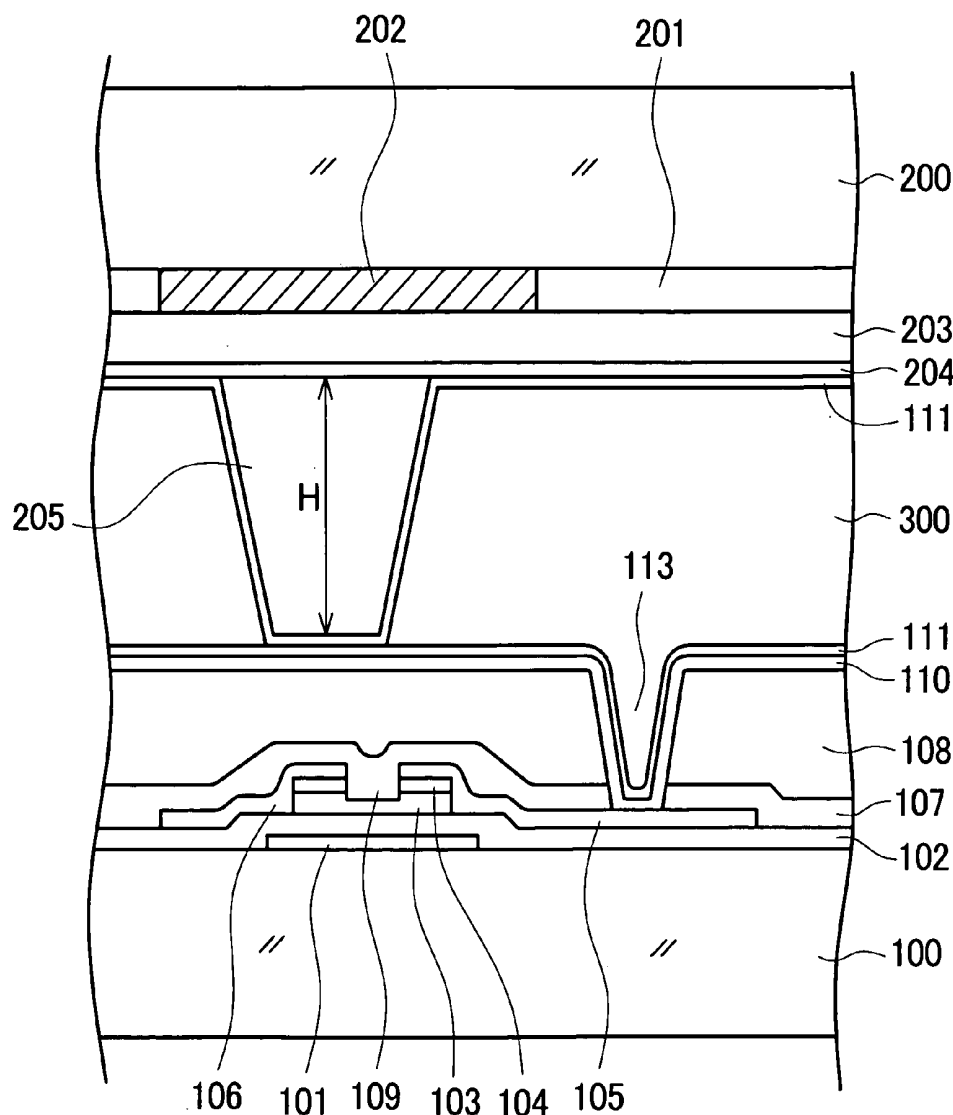


FIG. 1

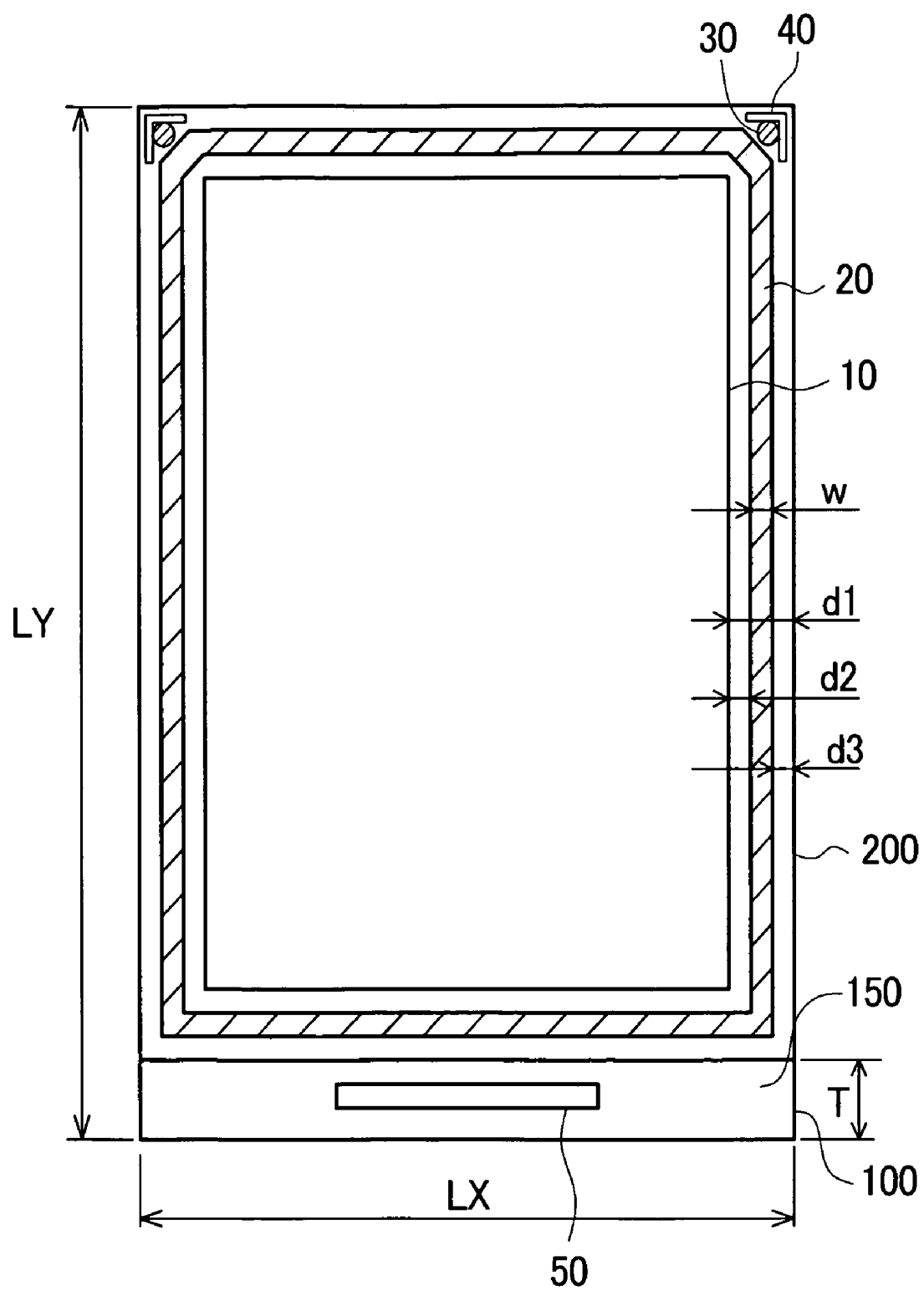


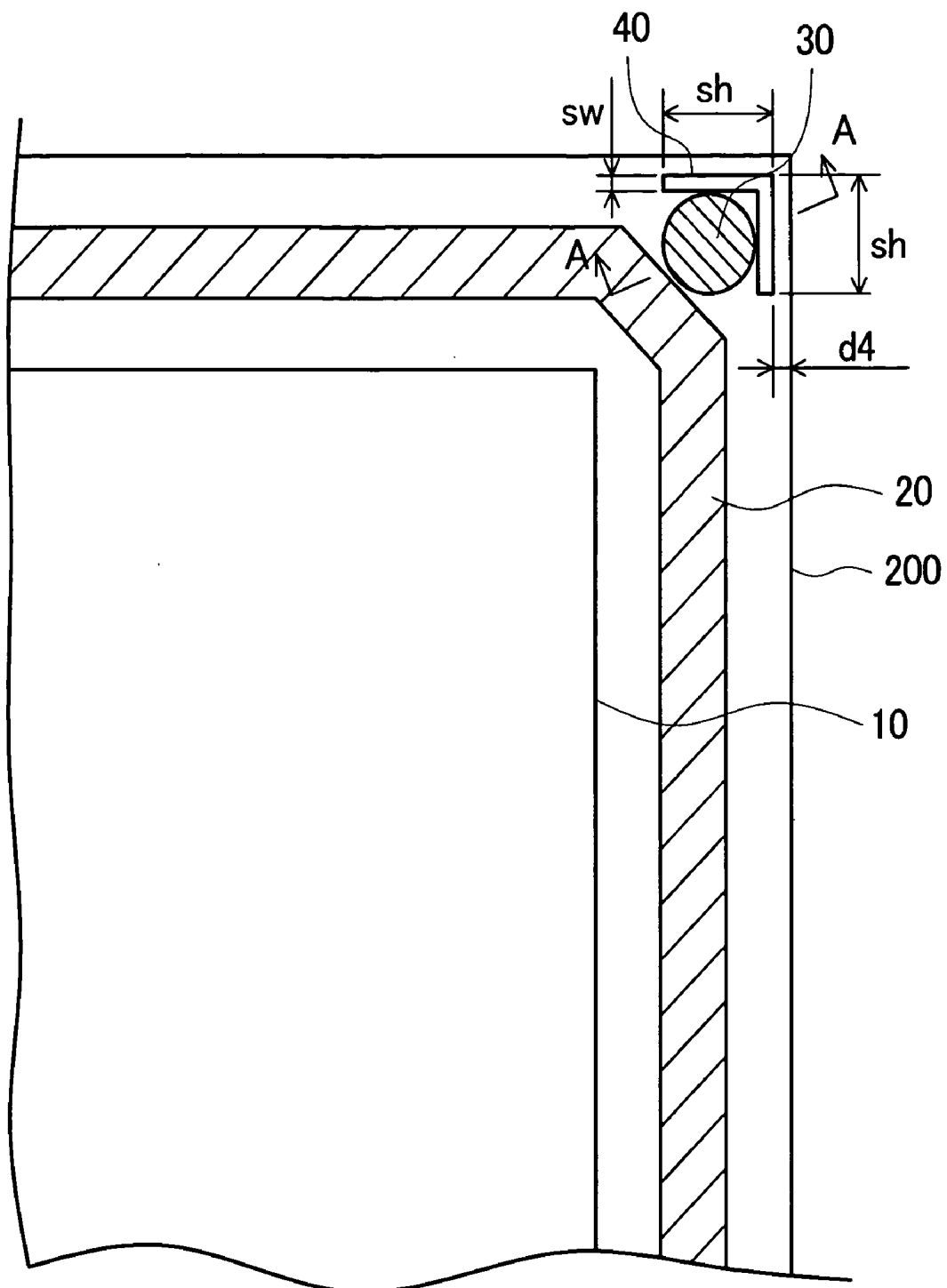
FIG. 2

FIG. 3

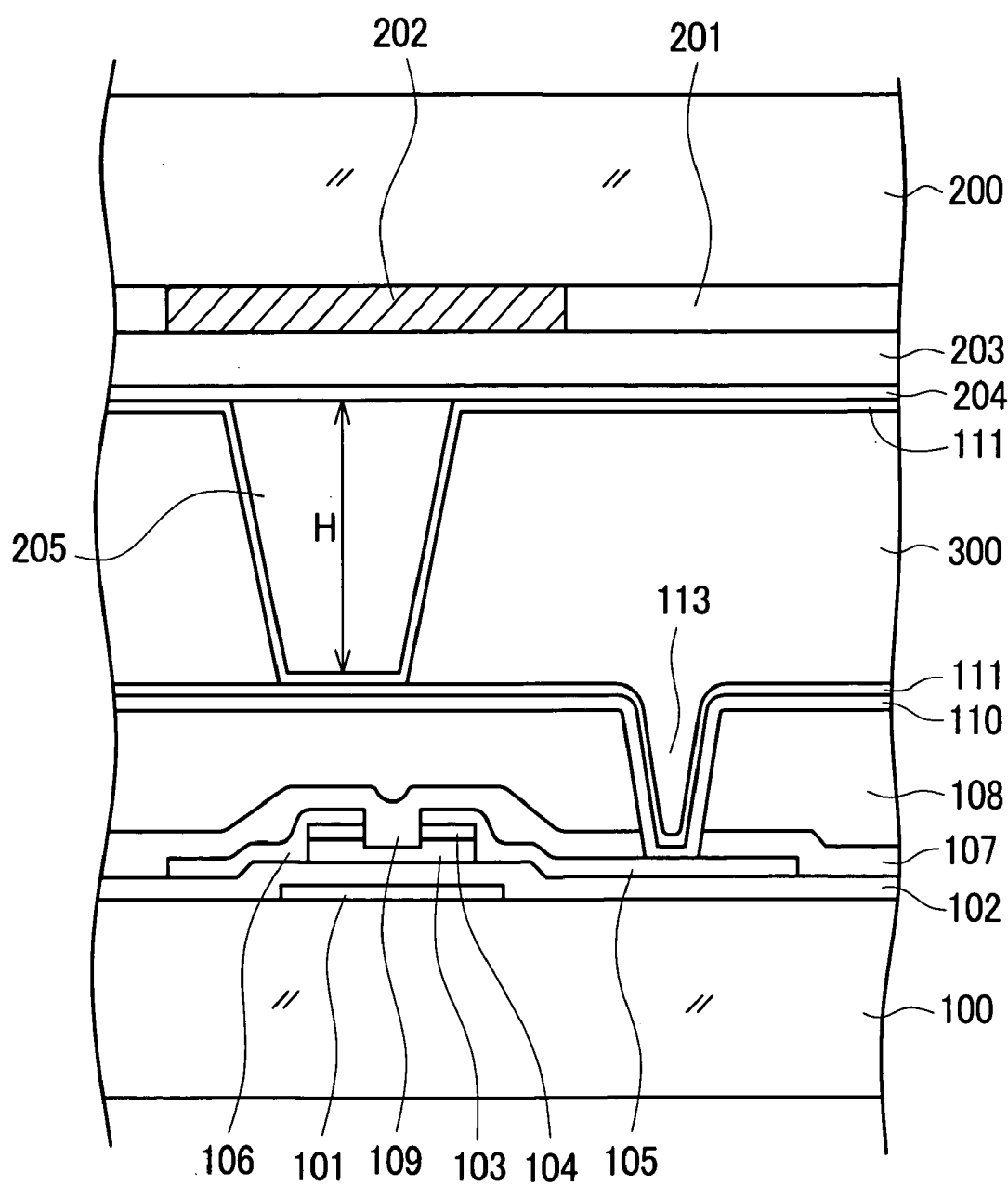


FIG. 4

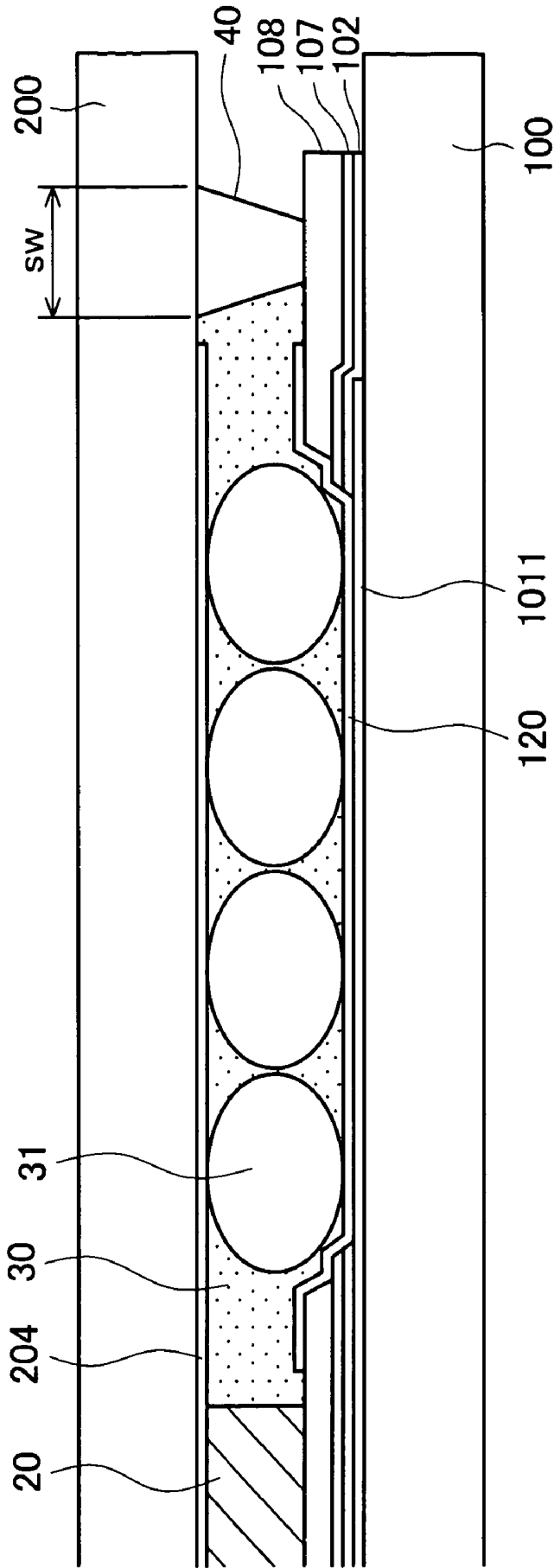


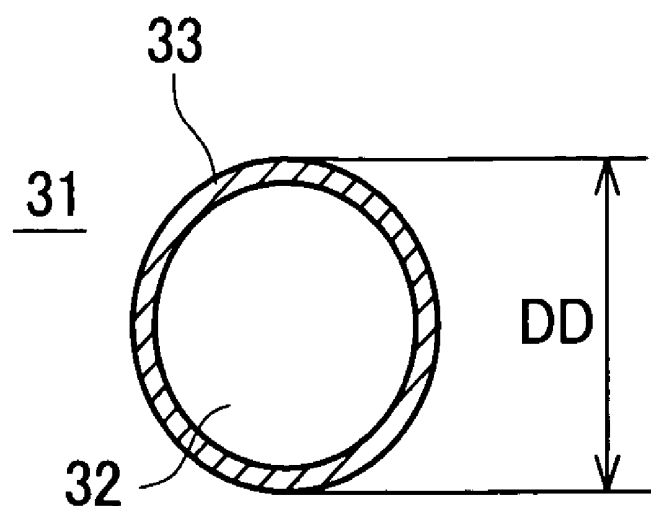
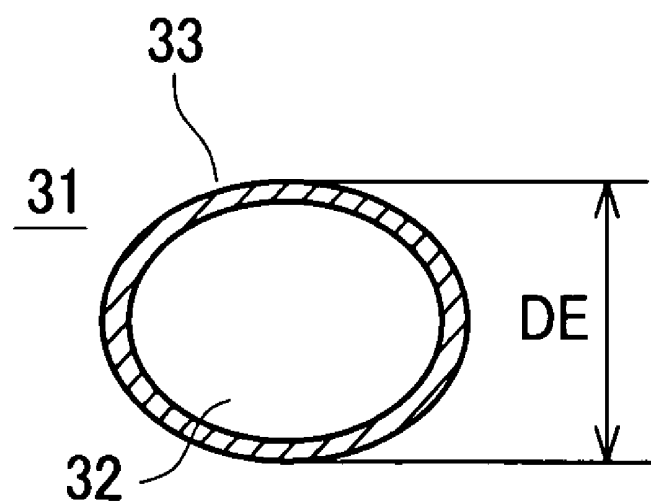
FIG. 5A*FIG. 5B*

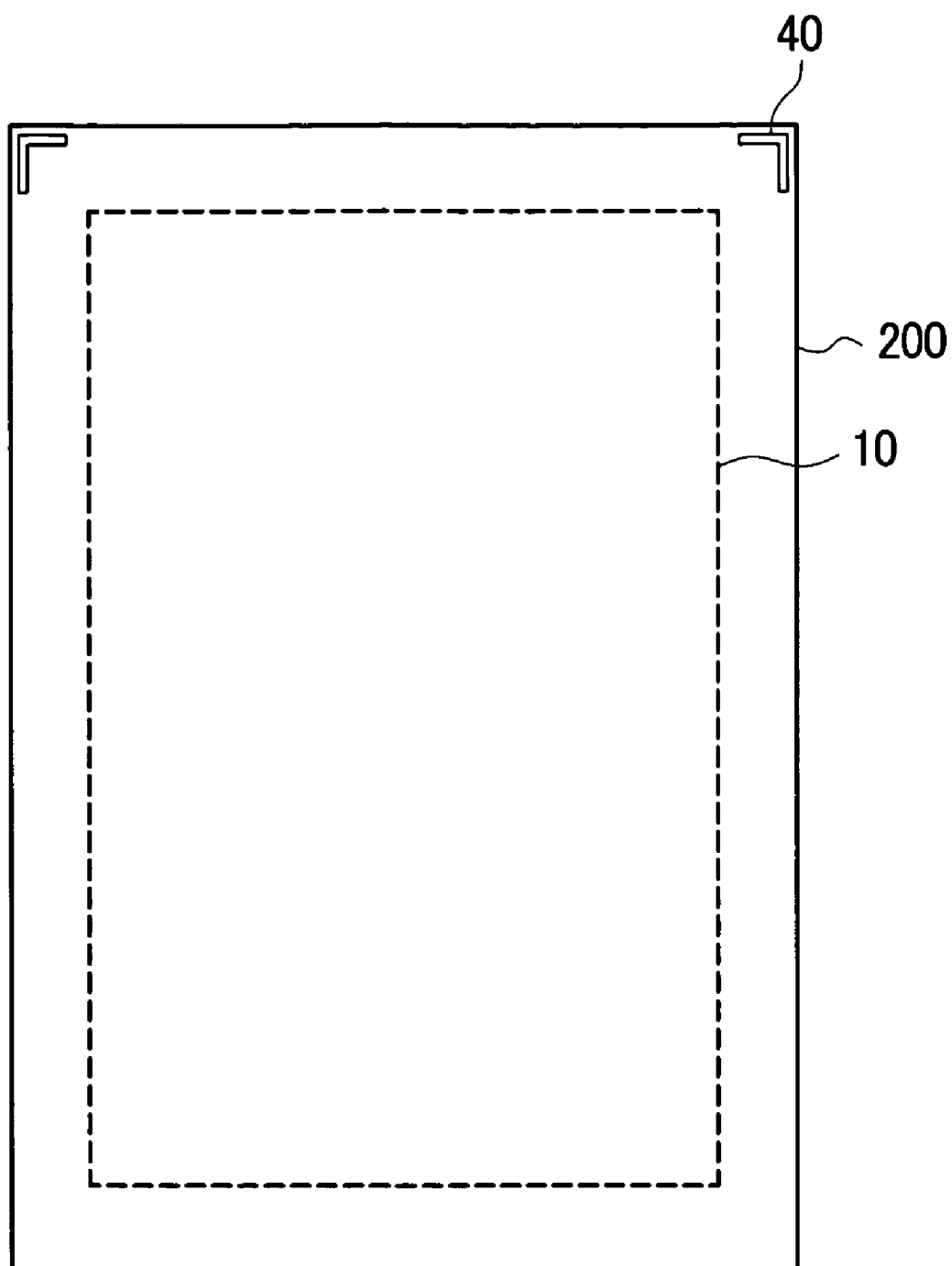
FIG. 6

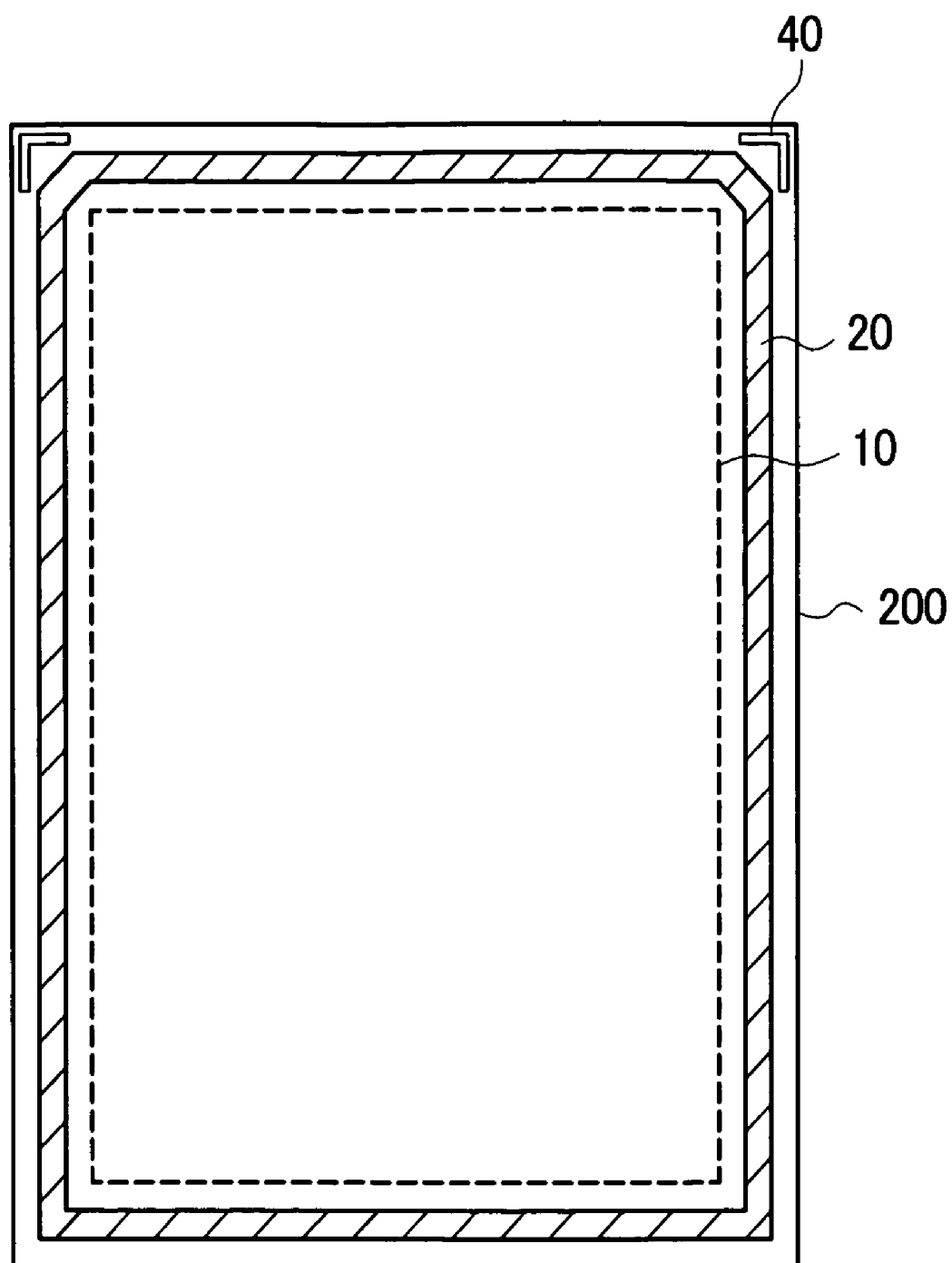
FIG. 7

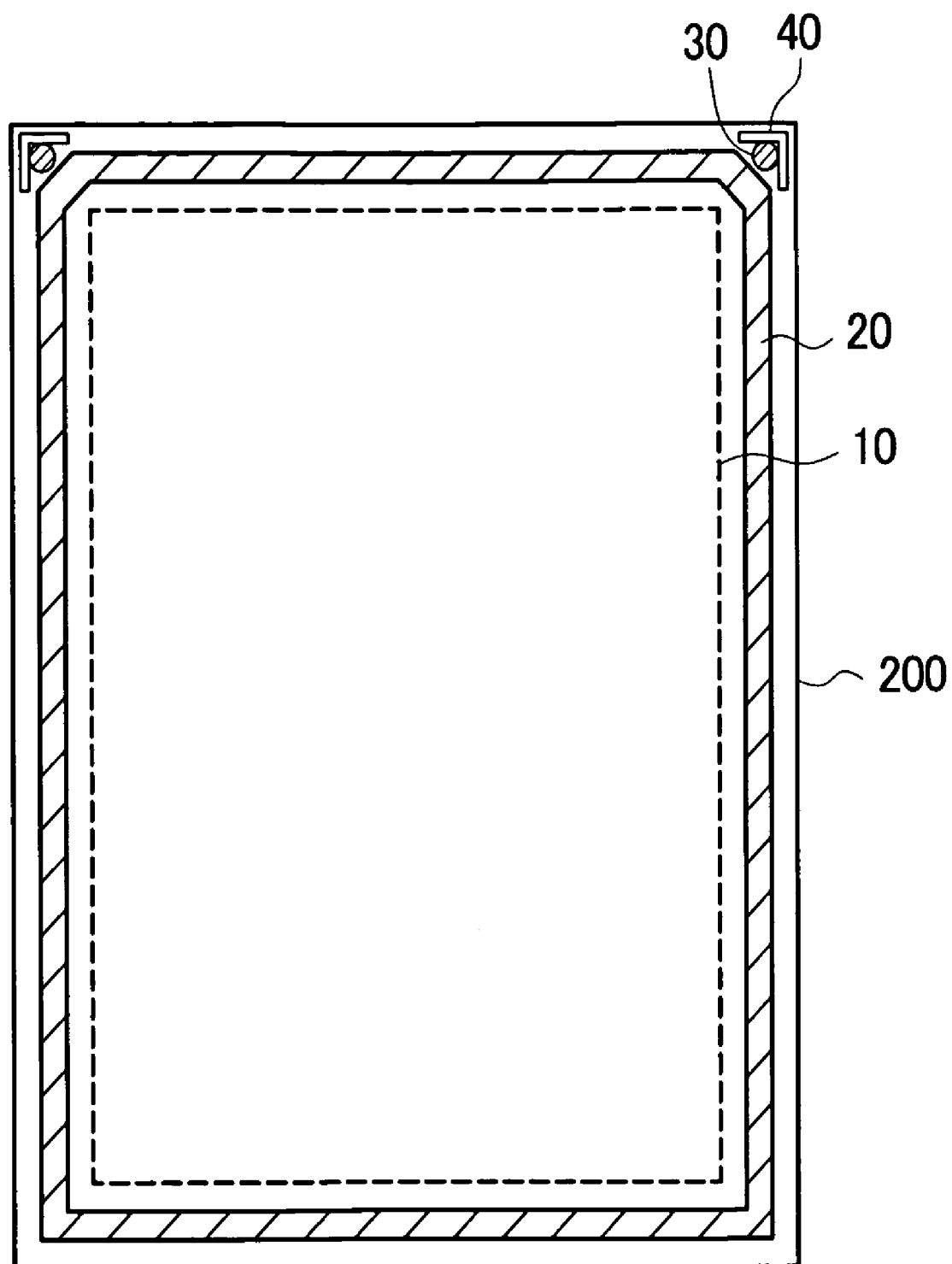
FIG. 8

FIG. 9

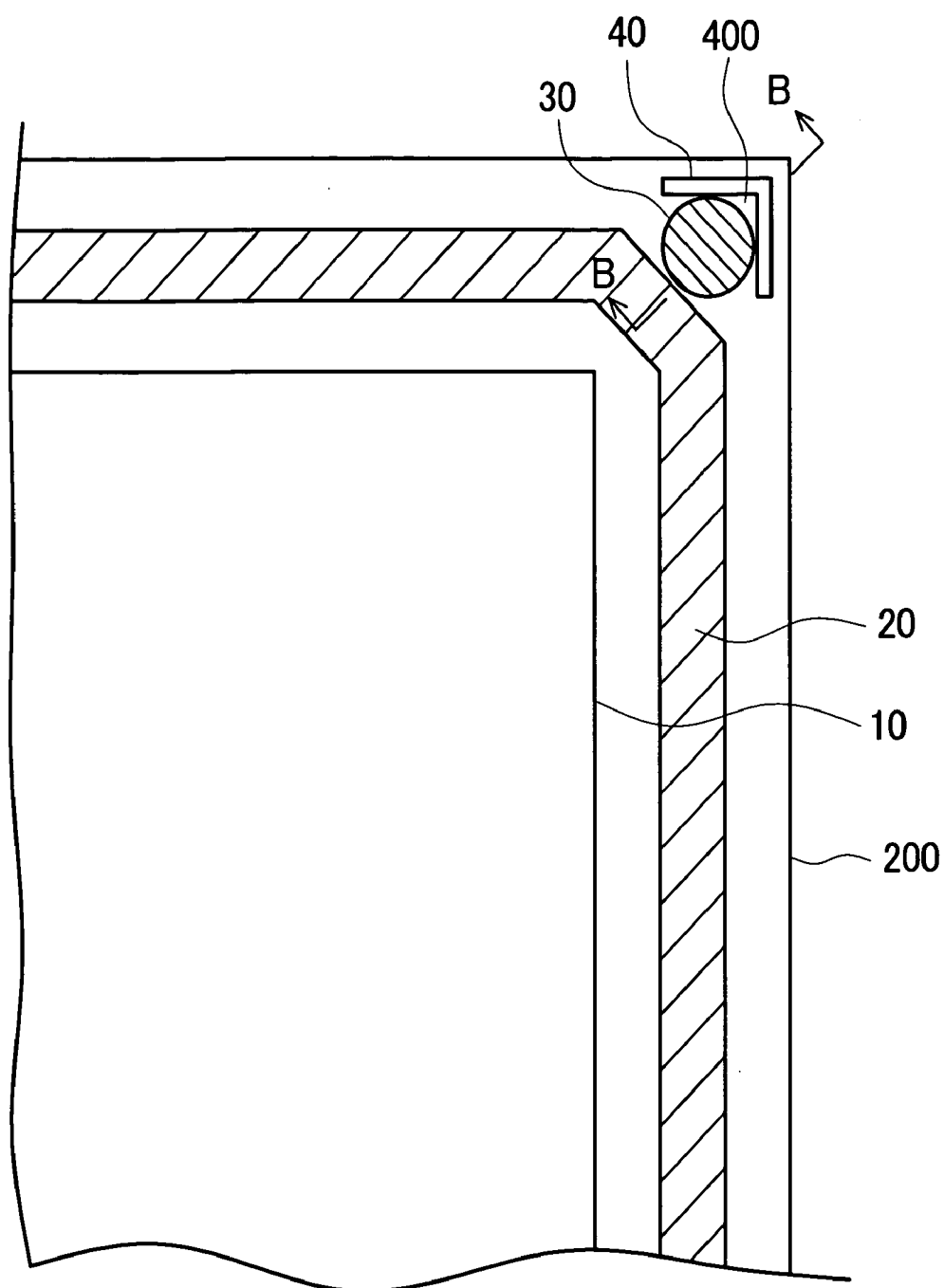


FIG. 10

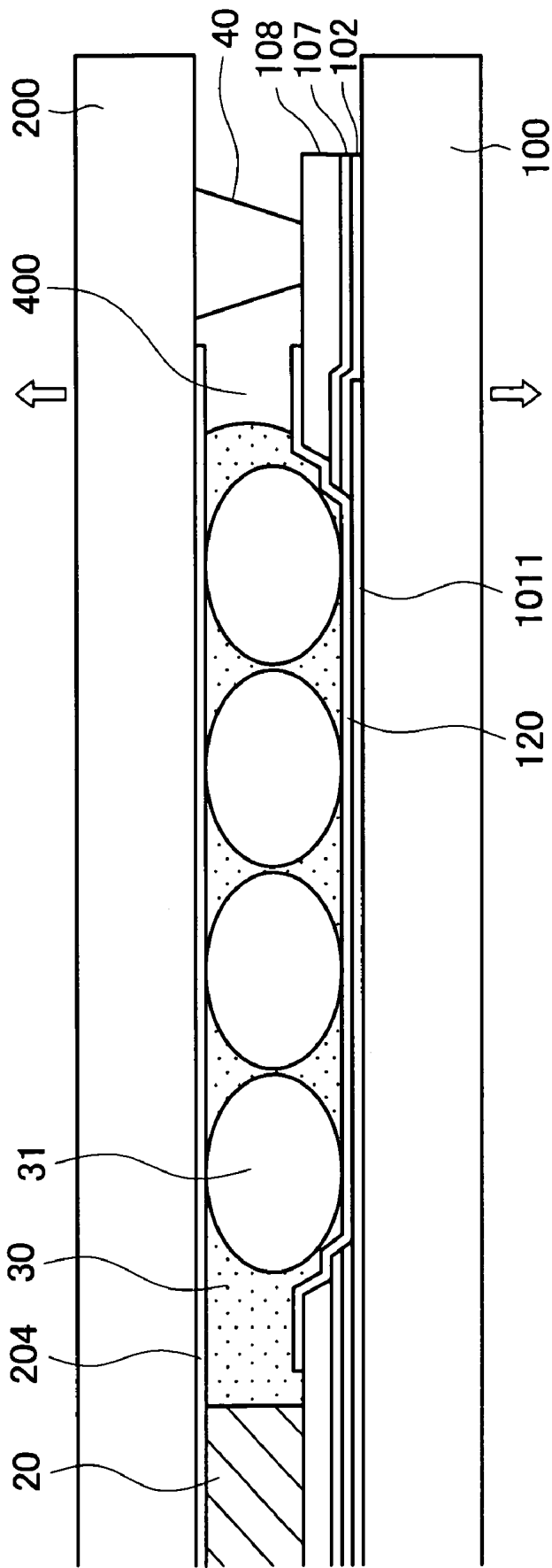
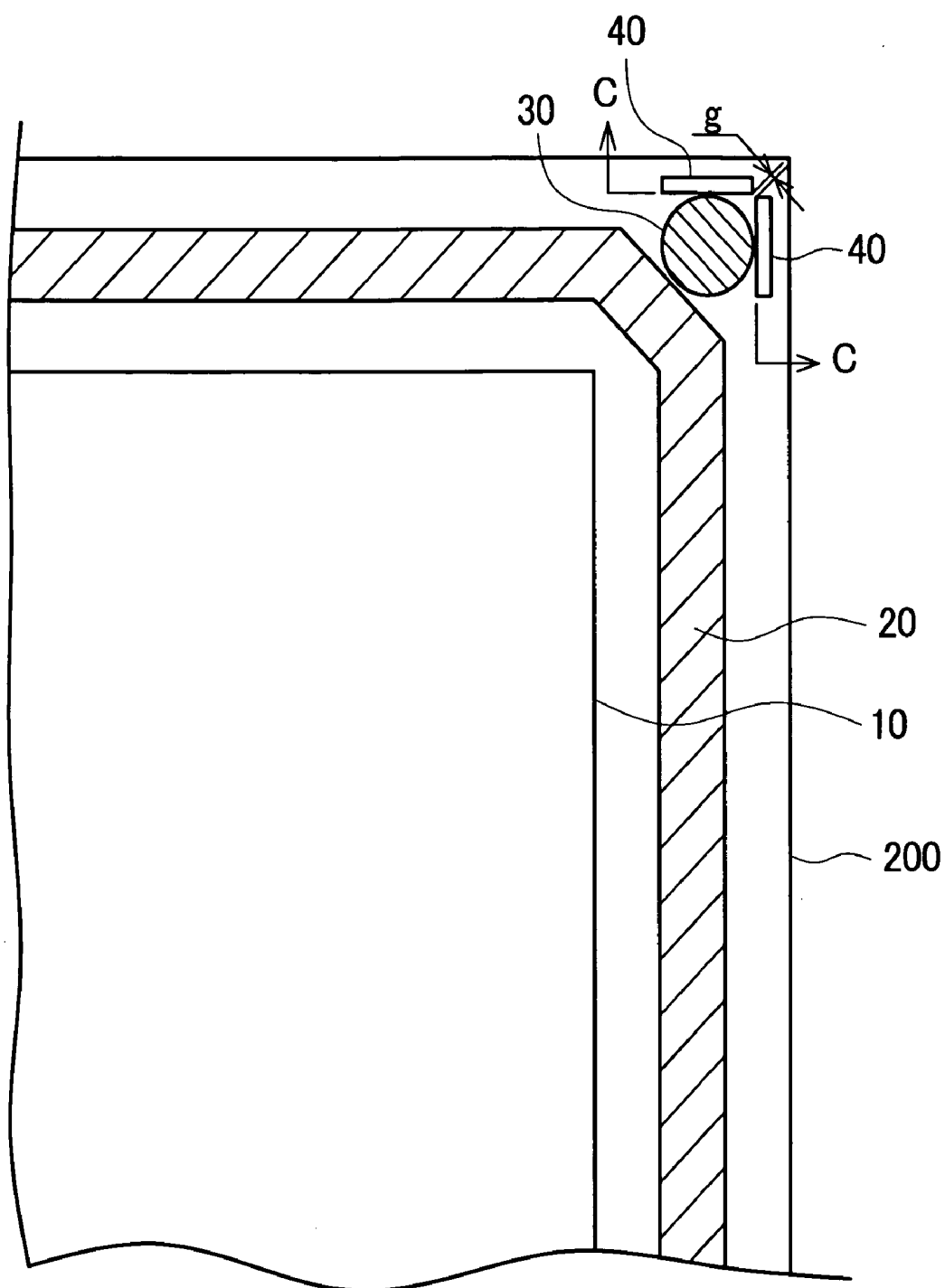


FIG. 11



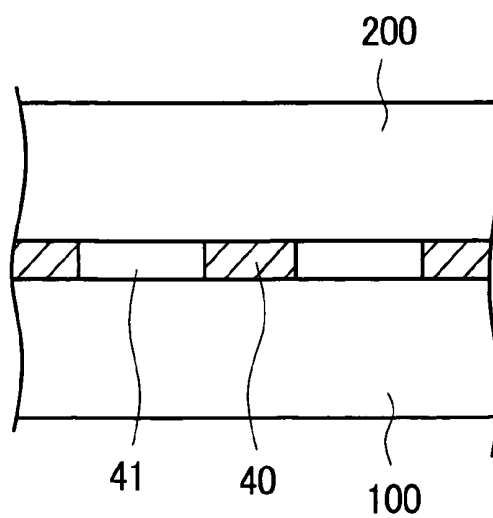


FIG. 14

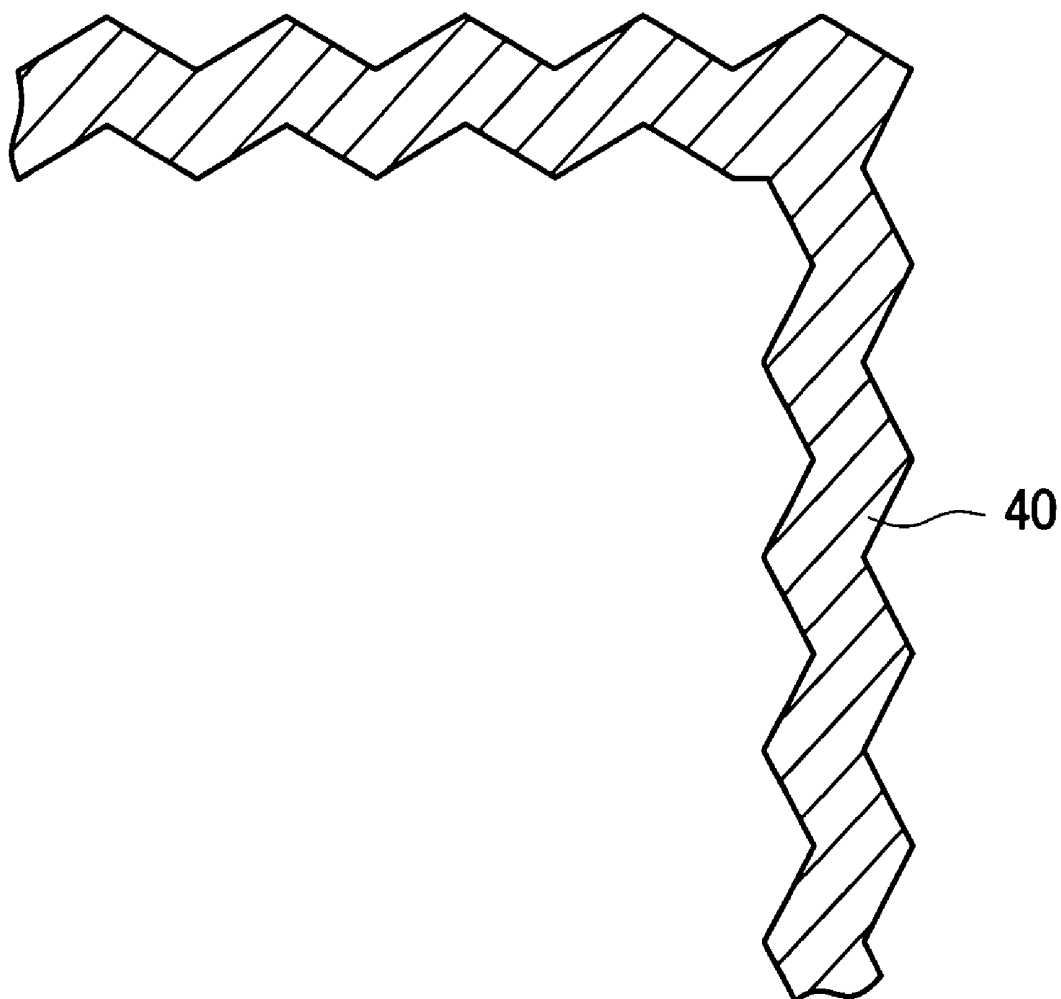
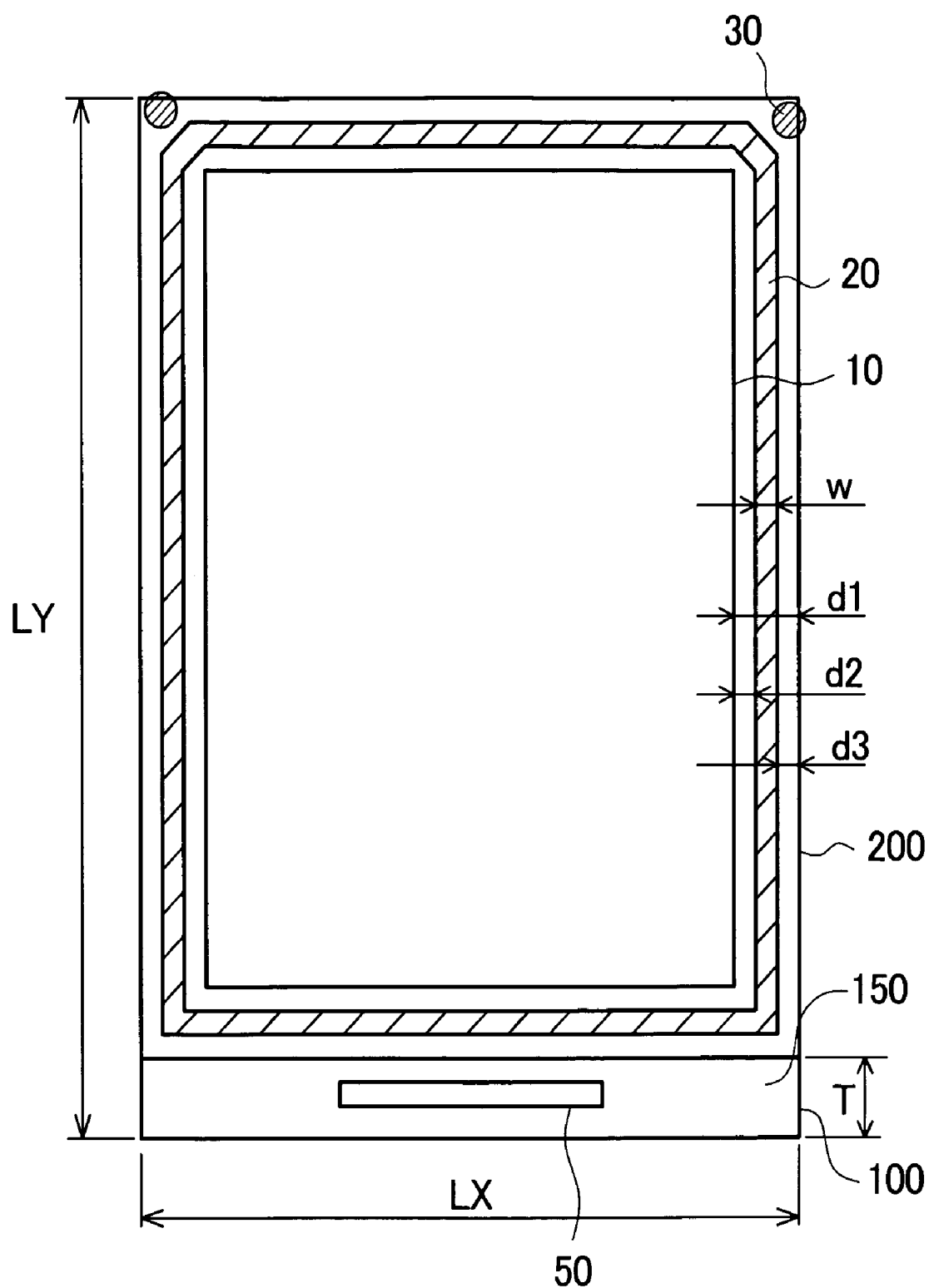


FIG. 15

Prior Art



LIQUID CRYSTAL DISPLAY DEVICE

[0001] The present application claims priority from Japanese application JP2008-87278 filed on Mar. 28, 2008, the content of which is hereby incorporated by reference into this application.

BACKGROUND OF THE INVENTION

[0002] 1. Field of the Invention

[0003] The present invention relates to a display device, and in particular, to a small flat-panel display device that has a large display region with respect to a small overall size.

[0004] 2. Description of the Related Art

[0005] In view of flat and lightweight, liquid crystal displays or organic EL displays are used for various purposes in various fields. In mobile phones or DSCs (Digital Still Camera), small liquid crystal displays or organic EL displays are widely used. These display devices need to have an overall size as small as possible. Meanwhile, in terms of ease of viewing, a display region is preferably sufficiently large. Therefore, there is a need for a display device that has a small overall size but a large display region.

[0006] A liquid crystal display has a TFT substrate, on which pixels each having a pixel electrode and a thin film transistor (TFT) are arranged in a matrix, a counter substrate that is opposed to the TFT substrate and has formed thereon color filters, and a liquid crystal layer that is interposed between the two substrates. The liquid crystal layer is sealed by a sealant, which is formed at the periphery between the TFT substrate and the counter substrate. The counter substrate has a counter electrode, which is formed to be opposed to the pixel electrodes of the TFT substrate. An image signal is applied between the pixel electrodes and the counter electrode, and transmitted light from a backlight or reflected light of external light is controlled for each pixel, thereby forming an image.

[0007] A common voltage is applied to the counter electrode of the counter substrate. The common voltage is supplied to a terminal portion of the TFT substrate, and is then supplied to the counter electrode of the counter substrate through a common wiring line of the TFT substrate. Accordingly, it is necessary to electrically connect the common wiring line of the TFT substrate and the counter electrode of the counter substrate. The electrical connection of the common wiring line of the TFT substrate and the counter electrode of the counter substrate is made by forming a conductive paste between the TFT substrate and the counter substrate. For example, a conductive paste, in which conductive beads are dispersed in a resin paste, is used. JP-A-2001-21909 discloses a technology that electrically connects the TFT substrate and the counter substrate by the conductive paste containing conductive beads.

SUMMARY OF THE INVENTION

[0008] If a display region 10 increases with a small overall size unchanged, a frame portion (also referred to as a frame or a frame region) has a small width. In the frame portion, scanning-line lead lines for supplying scanning signals to the pixels, and image-signal-line lead lines for supplying image signals are provided. If the frame portion becomes small, it is difficult to ensure a sufficient space for the scanning-line lead lines. Meanwhile, in the frame portion, a sealant 20 for bond-

ing a TFT substrate 100 and a counter substrate 200 needs to be formed. To reliably seal between the TFT substrate 100 and the counter substrate 200, the sealant 20 needs to be formed to have a predetermined width or more. In the frame portion, a conductive paste for connecting a common wiring line of the TFT substrate 100 and counter electrode of the counter substrate 200 is also formed. Accordingly, if the frame portion becomes small, there is a problem in that a space for the scanning-line lead lines, the sealant, and the conductive paste become small.

[0009] FIG. 15 is a plan view of a liquid crystal display, which is used in a mobile phone. Referring to FIG. 15, the counter substrate 200 is provided above the TFT substrate 100. A liquid crystal layer is interposed between the TFT substrate 100 and the counter substrate 200. The TFT substrate 100 and the counter substrate 200 are bonded to each other by the sealant 20 in the frame portion. The TFT substrate 100 is larger than the counter substrate 200. In a portion of the TFT substrate 100, excluding a portion overlapping the counter substrate 200, a terminal portion 150 for supplying power, image signals, and scanning signals to the liquid crystal display are formed. An IC driver 50 for driving scanning lines and image signal lines is also provided in the terminal portion 150.

[0010] Referring to FIG. 15, the liquid crystal display has a vertical length LY of 81 mm, and a horizontal length LX of 54 mm. The terminal portion 150, in which the IC driver 50 is mounted, has a width T of 2.7 mm. A width T between the display region 10 and an end of the TFT substrate 100 or the counter substrate 200, that is, the width of the frame portion is d1. If the width d1 of the frame portion is, for example, equal to or less than 1.5 mm, the following problems may occur.

[0011] In the frame portion, the scanning-line lead lines (not shown), the sealant, and a conductive paste 30, which connects the common wiring line of the TFT substrate 100 and the counter electrode of the counter substrate 200 are provided. In FIG. 15, when a distance d1 between an end of the display region 10 and an end of the counter substrate 200 is set to 1.5 mm, the width w of the sealant 20 is, for example, 0.6 mm, a distance d2 between the end of the display region 10 and an end of the sealant 20 is 0.4 mm, and a distance d3 between the other end of the sealant 20 and the end of the counter substrate 200 is 0.5 mm.

[0012] The conductive paste 30, which electrically connects the TFT substrate 100 and the counter substrate 200, is provided at a corner, as shown in FIG. 15. This is because the corner spatially affords. The conductive paste 30 is provided outside the sealant 20. The conductive paste 30 is dropped down and is then crushed on the counter substrate 200 through nozzles and spread when the TFT substrate 100 and the counter substrate 200 are bonded to each other. If the frame has a small area, a space for the conductive paste 30 is limited, and accordingly the conductive paste 30 may spread beyond the end of the counter substrate 200.

[0013] The liquid crystal display shown in FIG. 15 is plurally formed in large mother substrate, and is separated along a cutting line. As shown in FIG. 15, if the conductive paste 30 spreads, defective cutting may occur when each liquid crystal display is separated from them other substrate. For this reason, it is necessary to prevent the conductive paste 30 from spreading outside a predetermined region. Although FIG. 15 shows a case where the width d1 of the frame is 1.5 mm, the width d1 may be smaller than 1.5 mm, and the spread of the

conductive paste 30 may become worse. An object of the invention is to solve the above-described problems.

[0014] The invention has been finalized in order to achieve the above-described object, and may be embodied as the following aspects.

[0015] (1) According to a first aspect of the invention, a liquid crystal display device includes a TFT substrate that has a common wiring line for supplying a common voltage, a counter substrate that has a counter electrode, to which the common voltage is supplied, a sealant that bonds the TFT substrate and the counter substrate to each other, and liquid crystal that is sealed between the TFT substrate, the counter substrate, and the sealant. The counter substrate has a display region and a frame region, and a width of the frame region is defined by a distance from a side determining an end of the display region to an end of the counter substrate. The common wiring line of the TFT substrate and the counter electrode of the counter substrate are electrically connected by a conductive paste, the conductive paste is formed outside the sealant, and a stopper is formed on the counter substrate outside the conductive paste to prevent the conductive paste from flowing outward.

[0016] (2) According to a second aspect of the invention, in the liquid crystal display device according to the first aspect of the invention, the stopper may be provided at two corners of the counter substrate.

[0017] (3) According to a third aspect of the invention, in the liquid crystal display device according to the first or second aspect of the invention, the stopper may have an L shape.

[0018] (4) According to a fourth aspect of the invention, in the liquid crystal display device according to any one of the first to third aspects of the invention, the sealant may be made of epoxy resin, and the conductive paste may be formed by conductive beads in epoxy resin.

[0019] (5) According to a fifth aspect of the invention, in the liquid crystal display device according to any one of the first to fourth aspects of the invention, the width of the frame region may be equal to or less than 1.5 mm.

[0020] (6) According to a sixth aspect of the invention, a liquid crystal display device includes a TFT substrate that has a common wiring line for supplying a common voltage, a counter substrate that has a counter electrode, to which the common voltage is supplied, a sealant that bonds the TFT substrate and the counter substrate to each other, and liquid crystal that is sealed between the TFT substrate, the counter substrate, and the sealant. The counter substrate has a display region and a frame region, and a width of the frame region is defined by a distance from a side determining an end of the display region to an end of the counter substrate. The counter substrate has long and short sides. The common wiring line of the TFT substrate and the counter electrode of the counter substrate are electrically connected by a conductive paste, the conductive paste is formed outside the sealant, and a stopper is formed on the counter substrate outside the conductive paste to prevent the conductive paste from flowing outward. The stopper has a first stopper that is provided along a long-side corner of the counter substrate, and a second stopper that is provided along a short-side corner of the counter substrate, and a gap between the first stopper and the second stopper is in a range of 100 μm to 5 μm .

[0021] (7) According to a seventh aspect of the invention, in the liquid crystal display device according to the sixth aspect

of the invention, the gap between the first stopper and the second stopper may be in a range of 50 μm to 5 μm .

[0022] (8) According to an eighth aspect of the invention, in the liquid crystal display device according to the sixth or the seventh aspect of the invention, the first stopper and the second stopper may have a bar shape.

[0023] (9) According to a ninth aspect of the invention, in the liquid crystal display device according to any one of the sixth to eighth aspects of the invention, the stopper may be provided at two corners of the counter substrate to prevent the conductive paste from flowing outward.

[0024] (10) According to a tenth aspect of the invention, in the liquid crystal display device according to any one of the sixth to ninth aspects of the invention, the width of the frame region may be equal to or less than 1.5 mm.

[0025] (11) According to an eleventh aspect of the invention, a liquid crystal display device includes a TFT substrate that has a common wiring line for supplying a common voltage, a counter substrate that has a counter electrode, to which the common voltage is supplied, a sealant that bonds the TFT substrate and the counter substrate to each other, and liquid crystal that is sealed between the TFT substrate, the counter substrate, and the sealant. The counter substrate has a display region and a frame region, and a width of the frame region is defined by a distance from a side determining an end of the display region to an end of the counter substrate. In the display region, a columnar spacer is formed on the counter substrate to define a gap between the TFT substrate and the counter substrate. The common wiring line of the TFT substrate and the counter electrode of the counter substrate are electrically connected by a conductive paste, the conductive paste is formed outside the sealant, and a stopper is formed on the counter substrate outside the conductive paste to prevent the conductive paste from flowing outward. The stopper and the columnar spacer are made of the same material.

[0026] (12) According to a twelfth aspect of the invention, in the liquid crystal display device according to the eleventh aspect of the invention, the stopper and the columnar spacer may be formed by the same process.

[0027] (13) According to a thirteenth aspect of the invention, in the liquid crystal display device according to the eleventh or twelfth aspect of the invention, the stopper and the columnar spacer may have the same height.

[0028] (14) According to a fourteenth aspect of the invention, in the liquid crystal display device according to any one of the eleventh to thirteenth aspects of the invention, the width of the frame region may be equal to or less than 1.5 mm.

[0029] According to the aspects of the invention, in regards to a conductive paste for electrically connecting a common wiring line of a TFT substrate and a counter electrode of a counter substrate, a stopper is formed so as to prevent the conductive paste from flowing outward. For this reason, it is possible to retain the conductive paste within a predetermined region. Therefore, it is possible to cope with various problems caused by the flowing-out of the conductive paste. In particular, it is possible to suppress irregular defects of glass when being separated due to the flowing-out of the conductive paste when a liquid crystal display panel is separated from a mother substrate.

[0030] According to another aspect of the invention, a stopper for preventing a conductive paste from flowing outward is formed simultaneously with a columnar spacer, which is formed in a display region to define a gap between a TFT substrate and a counter substrate. As a result, it is possible to

reliably prevent the conductive paste from flowing outward without causing an increase in the number of steps of forming the stopper and an increase in costs.

BRIEF DESCRIPTION OF THE DRAWINGS

- [0031] FIG. 1 is a plan view of a liquid crystal display according to a first embodiment of the invention.
- [0032] FIG. 2 is an enlarged plan view of a corner shown in FIG. 1.
- [0033] FIG. 3 is a sectional view of a display region.
- [0034] FIG. 4 is a sectional view of a corner.
- [0035] FIGS. 5A and 5B are sectional view of a conductive bead.
- [0036] FIG. 6 is a plan view showing a case where a stopper is provided on a counter substrate.
- [0037] FIG. 7 is a plan view showing a case where a sealant is provided on a counter substrate.
- [0038] FIG. 8 is a plan view showing a case where a conductive paste is provided on a counter substrate.
- [0039] FIG. 9 is a plan view illustrating the object of a second embodiment of the invention.
- [0040] FIG. 10 is a sectional view illustrating the object of the second embodiment.
- [0041] FIG. 11 is a plan view showing a liquid crystal display according to the second embodiment.
- [0042] FIG. 12 is a sectional view of a stopper according to the second embodiment.
- [0043] FIGS. 13A and 13B show the shape of a stopper according to a third embodiment of the invention.
- [0044] FIG. 14 shows the shape of a stopper according to the third embodiment.
- [0045] FIG. 15 is a plan view of a known liquid crystal display.

DESCRIPTION OF PREFERRED EMBODIMENTS

[0046] The invention will be described in detail in connection with the following embodiments.

First Embodiment

[0047] FIG. 1 shows a liquid crystal display for a mobile phone, to which the invention is applied. In FIG. 1, a TFT substrate 100, a counter substrate 200, a liquid crystal layer 300, a terminal portion 150, an IC driver 50, and a sealant 20 are provided at the same positions as those of the liquid crystal display shown in FIG. 15. The liquid crystal display shown in FIG. 1 has the same external shape as described with reference to FIG. 15. That is, the liquid crystal display shown in FIG. 1 has a vertical length LY of 81 mm and a horizontal length LX of 54 mm, and the terminal portion 150 in which the IC driver 50 is mounted has a width T of 2.7 mm. A width between a display region 10 and an end of the TFT substrate 100 or the counter substrate 200, that is, the width d1 of a frame portion is, for example, 1.5 mm. The invention may be applied even though the width d1 is less than 1.5 mm. Hereinafter, a case where the width d1 of the frame portion is 1.5 mm will be described.

[0048] In FIG. 1, the width w of the sealant 20 is 0.6 mm, a distance d2 between an end of the display region 10 and an end of the sealant 20 is 0.4 mm, and a distance d3 between the other end of the sealant 20 and an end of the counter substrate 200 is 0.5 mm. In this embodiment, since liquid crystal is dropped down on the counter substrate 200 by dropping, in

FIG. 1, the sealant 20 is continuously provided all around. When liquid crystal is injected through an injection hole, the injection hole is formed by partially cutting the sealant 20.

[0049] A common voltage is applied to a counter electrode 204 of the counter substrate 200, such that an electric field is formed between the counter electrode 204 and a pixel electrode 110 in each pixel of the TFT substrate 100 to control liquid crystal molecules. The common voltage is supplied from the outside through a common terminal and a common wiring line 1011 connected to the common terminal, which are formed on the TFT substrate 100.

[0050] For electrical connection between the common wiring line 1011 formed on the TFT substrate 100 and the counter electrode 204 formed on the counter substrate 200, as shown in FIG. 1, conductive pastes 30 are provided at corners. This is because the corners spatially afford for the conductive pastes 30. At lower corners of the counter substrate 200 shown in FIG. 1, wiring lines are closely spaced, and accordingly a sufficient space for the conductive pastes 30 may not be ensured.

[0051] In a liquid crystal display, to which the invention is applied, the width d1 of the frame portion is small, and thus a sufficient space for the conductive pastes 30 is not ensured. For this reason, as described above, the conductive paste 30 may flow out of a predetermined region. In the liquid crystal display, the frame portion is formed in both the TFT substrate 100 and the counter substrate 200, but for clear definition, it is assumed that a dimension from the display region 10 is defined as the dimension of the frame portion in the counter substrate 200. In this embodiment, as shown in FIG. 1, an L-shaped stopper 40 is provided at the corner at which each conductive paste 30 is provided, to thereby prevent the conductive paste 30 from flowing out of a specific region.

[0052] FIG. 2 is an enlarged plan view of a corner, at which the conductive paste 30 is provided, in FIG. 1. Specifically, FIG. 2 is a perspective view showing the state of a corner in a state where the TFT substrate 100 and the counter substrate 200 are superimposed on each other. Referring to FIG. 2, the L-shaped stopper 40 is provided at the corner. The conductive paste 30 is dropped down inside the stopper 40. The conductive paste 30 is a liquid having high viscosity. At the corner, the sealant 20 is chamfered in order to ensure a space for the conductive paste 30.

[0053] As described below, the L-shaped stopper 40, the conductive paste 30, and the sealant 20 are initially provided on the counter substrate 200, and then the counter substrate 200 and the TFT substrate 100 are superimposed on each other. In FIG. 2, the sealant 20 is made of epoxy resin, and is formed on the counter substrate 200 by printing. The L-shaped stopper 40 is formed simultaneously with columnar spacers 205 for defining a gap between the counter substrate 200 and the TFT substrate 100 in the display region 10. The conductive paste 30 is formed by dispersing conductive beads 31 as described latter in the same epoxy-based resin as the sealant 20.

[0054] In FIG. 2, the L-shaped stopper 40 has a width sw of 10 μ m and the length of a side thereof is 0.5 mm. The height of the L-shaped stopper 40 is the same as the columnar spacers 205 in the display region 10, that is, approximately 4 μ m. That is, the L-shaped stopper 40 has an elongated shape. Even though the L-shaped stopper 40 is so elongated, it is possible to sufficiently achieve the effect of the stopper 40 for stopping the conductive paste 30.

[0055] A distance **d4** between an outer end of the stopper **40** and an end of the counter substrate **200** is approximately 0.2 mm. The distance **d4** is defined by accuracy of a scribing machine when each liquid crystal display panel is separated from a mother substrate. The stopper **40** enables to reliably prevent the conductive paste **30** from flowing out of a specific region. Thus, even though the width of the frame portion becomes small, it is possible to suppress defectives when a liquid crystal display panel is separated.

[0056] FIG. 3 is a sectional view of the liquid crystal display in the display region **10**. Referring to FIG. 3, a gate electrode **101** is formed on the TFT substrate **100**. The gate electrode **101** is formed by sputtering and then patterned by photolithography. The gate electrode **101** is made of aluminum (Al), and has a thickness of approximately 300 nm. A scanning line is formed in the same layer as the gate electrode **101** at a time. The common wiring line **1011**, which is formed on the TFT substrate **100** to supply the common voltage to the counter electrode **204** of the counter substrate **200**, is also formed in the same layer as the gate electrode **101** at a time. A gate insulating layer **102** is formed to cover the gate electrode **101**. The gate insulating layer **102** is formed by depositing a SiN film by a CVD method. The gate insulating layer **102** has a thickness of approximately 400 nm.

[0057] A semiconductor layer **103** is formed on the gate electrode **101** with the gate insulating layer **102** interposed therebetween. The semiconductor layer **103** is made of a-Si, and has a thickness of approximately 150 nm. A channel region of a TFT is formed in the a-Si layer. An n-doped (n+) Si layer **104** is formed before a source electrode **105** and a drain electrode **106** are formed in the a-Si layer. The n-doped (n+) Si layer is to form an ohmic contact between the a-Si layer **103** and the source electrode **105** or the drain electrode **106**.

[0058] The source electrode **105** or the drain electrode **106** is formed on the n-doped (n+) Si layer **104**. An image signal line is formed in the same layer as the source electrode **105** or the drain electrode **106**. The source electrode **105** or the drain electrode **106** is made of molybdenum (Mo) or aluminum (Al). When source electrode **105** or the drain electrode **106** is made of Al, it is covered with Mo on both sides. This is to prevent contact resistance from being unstable when Al comes into contact with ITO in a contact hole **113**.

[0059] After the source electrode **105** or the drain electrode **106** is formed, channel etching is executed with the source electrode **105** and the drain electrode **106** as a mask. Etching is executed to an upper part of the a-Si layer in order to completely remove the n-doped (n+) Si layer **104** from the channel layer, thereby forming a channel etching region **109**. Thereafter, an inorganic passivation layer **107** is formed to cover the entire TFT. The inorganic passivation layer **107** is made of SiN. The inorganic passivation layer **107** has a thickness of approximately 400 nm, for example.

[0060] An organic passivation layer **108** is formed to cover the inorganic passivation layer **107**. The organic passivation layer **108** functions as a planarization layer, and thus it is formed thick, for example, approximately 2 μ m. The organic passivation layer **108** is made of acrylic resin. Specifically, the organic passivation layer **108** is made of photosensitive acrylic resin, such that patterning may be executed with no resist.

[0061] Therefore, a contact hole **113** is formed to pass through the organic passivation layer **108** and the inorganic passivation layer **107**. This is to electrically connect the pixel

electrode **110** made of ITO and the source electrode **105** of the TFT. The pixel electrode **110** made of ITO is formed on the organic passivation layer **108**.

[0062] Referring to FIG. 3, an alignment layer **111** for aligning the liquid crystal molecules is formed on the pixel electrode **110**. The liquid crystal layer **300** is interposed between the TFT substrate **100** and the counter substrate **200**. The liquid crystal molecules of the liquid crystal layer **300** are initially aligned by the alignment layer **111** formed on the TFT substrate **100** and an alignment layer **111** formed on the counter substrate **200**.

[0063] Referring to FIG. 3, a color filter **201** is formed inside the counter substrate **200**. For each pixel, the color filter **201** of red, green, or blue is formed, thereby forming a color image. A black matrix (light-blocking layer) **202** is formed between the color filters **201** in order to improve contrast of an image. The black matrix **202** also serves as a light-blocking layer for the TFT to prevent a photocurrent from flowing in the TFT.

[0064] An overcoat layer **203** is formed to cover the color filter **201** and the black matrix **202**. The color filter **201** and the black matrix **202** have an uneven surface, and the overcoat layer **203** planarizes the uneven surface. The counter electrode **204** made of a transparent conductive film, such as ITO, is formed on the overcoat layer **203**. If a voltage is applied between the pixel electrode **110** in each pixel of the TFT substrate **100** and the counter electrode **204** of the counter substrate **200**, the liquid crystal molecules are rotated to control transmitted light or reflected light, thereby forming an image.

[0065] The columnar spacer **205** is formed on the counter electrode **204** in order to define the gap between the counter substrate **200** and the TFT substrate **100**. The columnar spacer **205** is formed in a portion where the black matrix **202** is formed so as not to transmit light from a backlight. This is because a portion of the columnar spacer **205** disturbs the alignment of liquid crystal, causes light leakage from the backlight, and deteriorates contrast.

[0066] The height **H** of the columnar spacer **205** is the same as the thickness of the liquid crystal layer **300**, for example, 4 μ m. The L-shaped stopper **40** shown in FIG. 2 is formed simultaneously with the columnar spacer **205**. Therefore, the columnar spacer **205** and the L-shaped stopper **40** have the same height. In addition, the columnar spacer **205** and the L-shaped stopper **40** are made of the same material. The columnar spacer **205** is made of, for example, photosensitive acrylic resin. The acrylic resin is coated on the entire surface of the counter substrate **200**. Then, if exposure is executed using a mask, only an exposed portion is insoluble in a developer, and thus only the exposed portion remains as the columnar spacer **205** (or the stopper **40**). The use of the photosensitive resin ensures removal of a resist process and reduction in a process.

[0067] An alignment layer **111** is formed to cover the columnar spacer **205** and the counter electrode **204**. The liquid crystal layer **300** is initially aligned by the alignment layer **111** on the TFT substrate **100** and the alignment layer **111** on the counter substrate **200**. An electric field, which is formed between the pixel electrode **110** of the TFT substrate **100** and the counter electrode **204** of the counter substrate **200**, is applied to the initially aligned liquid crystal molecules to rotate the liquid crystal molecules. In this way, light transmitting the liquid crystal layer **300** is controlled, thereby

forming an image. In this embodiment, as described with reference to FIG. 1, liquid crystal is dropped down and filled by dropping.

[0068] FIG. 4 is a sectional view taken along the line A-A of FIG. 2. Referring to FIG. 4, the conductive paste 30 is provided between the sealant 20 and the L-shaped stopper 40. Conductive beads 31 are dispersed in the conductive paste 30. The conductive beads 31 ensure electrical connection between the common wiring line 1011 of the TFT substrate 100 and the counter electrode 204 of the counter substrate 200. The conductive paste 30 is made of the same epoxy resin as the sealant 20, and is curable on the same condition as the sealant 20.

[0069] FIGS. 5A and 5B are schematic sectional views of a conductive bead 31. FIG. 5A shows a conductive bead 31 having a spherical shape. The conductive bead 31 is formed by coating a plastic bead 32 with a metal thin film, such as gold, and has conductivity due to the metal thin film (conductive coat 33). The conductive bead 31 shown in FIG. 5A has, for example, a diameter DD of 6 μm . If the conductive paste 30, in which the conductive beads 31 shown in FIG. 5A are dispersed, is provided on the counter substrate 200, and the TFT substrate 100 and the counter substrate 200 are bonded to each other, the conductive beads 31 are crushed and have the same shape as shown in FIG. 5B. A short diameter DE shown in FIG. 5B after the conductive bead 31 is crushed is, for example, 5 μm . As the conductive bead 31 is crushed, the conductive bead 31 comes into close contact with the common wiring line 1011 of the TFT substrate 100 and the counter electrode 204 of the counter substrate 200.

[0070] Returning to FIG. 4, the common wiring line 1011, which is formed in the same layer as the gate electrode 101, extends on the TFT substrate 100. The gate insulating layer 102, the inorganic passivation layer 107, and the organic passivation layer 108 are provided on the common wiring line 1011. In a portion where the common wiring line 1011 and the counter electrode 204 are electrically connected to each other, a contact hole is formed to pass through the gate insulating layer 102, the inorganic passivation layer 107, and the organic passivation layer 108, to thereby expose the common wiring line 1011.

[0071] The common wiring line 1011 is made of Al, and it may corrode when being exposed to an external environment. For this reason, the contact hole is covered with a chemically stable metal oxide conductive layer 120. The metal oxide conductive layer 120 is made of ITO. The metal oxide conductive layer 120 made of ITO is formed simultaneously with the pixel electrode 110 in the display region 10.

[0072] On the counter substrate 200, the counter electrode 204 made of ITO extends from the display region 10. The counter electrode 204 of the counter substrate 200 and the common wiring line 1011 of the TFT substrate 100 are connected to each other by the conductive beads 31. The stopper 40 is formed in order to prevent the conductive paste 30 having dispersed therein the conductive beads 31 from flowing beyond a cutting line of a liquid crystal display panel.

[0073] The stopper 40 is formed simultaneously with the columnar spacers 205 in the display region 10, and thus it has the same height as the columnar spacers 205. The stopper 40 is formed by depositing acrylic resin on the counter substrate 200 and executing exposure and development. Therefore, as shown in FIG. 4, the width of the stopper 40 on the counter substrate 200 is larger than the width of the stopper 40 on the

TFT substrate 100. The width sw of the stopper 40 shown in FIG. 2 is the width of the stopper 40 on the counter substrate 200.

[0074] On the TFT substrate 100, the gate insulating layer 102, the inorganic passivation layer 107, and the organic passivation layer 108 are also formed in a portion where the stopper 40 is formed. The stopper 40 on the counter substrate 200 comes into contact with the organic passivation layer 108 on the TFT substrate 100 with no gap.

[0075] FIGS. 6 to 8 are diagrams illustrating a process in which the L-shaped stoppers 40, the sealant 20, and the conductive pastes 30 are provided on the counter substrate 200. As shown in FIG. 6, first, the L-shaped stoppers 40 are individually provided at two corners of the counter substrate 200. The stoppers 40 are formed simultaneously with the columnar spacers 205 for defining the gap between the TFT substrate 100 and the counter substrate 200 in the display region 10. In FIG. 6, a portion surrounded by a dotted line is the display region 10, and the description of the display region 10 is omitted.

[0076] Next, as shown in FIG. 7, the sealant 20 is formed outside of the display region 10 by screen printing. The sealant 20 may be formed by a dispenser, but in terms of an accurate shape, it is preferably formed by screen printing. The sealant 20 is made of epoxy resin. In this embodiment, liquid crystal is dropped down on the counter substrate 200 by dropping, and thus the sealant 20 is continuously formed, as shown in FIG. 7. When liquid crystal is injected, an injection hole is formed in the sealant 20.

[0077] Next, the conductive paste 30 is dropped down between the sealant 20 and the L-shaped stopper 40 through nozzles. The amount of the conductive paste to be dropped down is accurately controlled. Since the conductive paste 30 is made of epoxy resin, screen printing may be used. However, when the sealant 20 is coated by screen printing, the conductive paste 30 is provided by using the nozzles, instead of screen printing.

[0078] Thereafter, liquid crystal is dropped down inside the sealant 20, and is sealed by bonding the counter substrate 200 and the TFT substrate 100 to each other. The sealant 20 is thermally cured. Since the sealant 20 is made of the same epoxy resin as the conductive paste 30, the sealant 20 and the conductive paste 30 are simultaneously cured on the same thermal curing condition.

[0079] As described above, according to the first embodiment of the invention, the stopper 40 is formed outside a portion where the conductive paste 30 is provided. Therefore, it is possible to reliably prevent the conductive paste 30 from flowing out of a predetermined region. In particular, in case of a small liquid crystal display in which the width of the frame is equal to or less than 1.5 mm, it is also possible to reliably prevent the conductive paste 30 from flowing out. Furthermore, it is possible to simultaneously form the stoppers 40 and the columnar spacer 205 in the display region 10, and thus it is possible to suppress an increase in manufacturing costs.

Second Embodiment

[0080] FIG. 9 is a plan view illustrating a problematic phenomenon in the structure of the first embodiment. FIG. 9 is the same as FIG. 2 of the first embodiment, but it shows an example where air 400 exists between the stopper 40 and the conductive paste 30 at the corner. When the counter substrate 200 and the TFT substrate 100 are bonded to each other, air 400 may enter in the L-shaped stopper 40. In this case, the gap

between the TFT substrate **100** and the counter substrate **200** may become unstable, and the conductive paste **30** may be not in close contact with the TFT substrate **100** and the counter substrate **200**, which may result in poor contact.

[0081] FIG. **10** is a sectional view taken along the line B-B of FIG. **9**. The structure shown in FIG. **10** is the same as that shown in FIG. **4**. In FIG. **10**, however, air **400** exists between the stopper **40** and the conductive paste **30**. The sealant **20** or the conductive paste **30** is made of epoxy-based thermosetting resin. When the counter substrate **200** and the TFT substrate **100** are bonded to each other, and the sealant **20** or the conductive paste **30** is thermally cured, air **400** near the stopper **40** is expanded, the TFT substrate **100** and the counter substrate **200** are pushed in a direction indicated by an arrow in FIG. **10**. Accordingly, the gap between the TFT substrate **100** and the counter substrate **200** becomes unstable, and then electrical connection by the conductive beads **31** in the conductive paste **30** becomes unstable. For this reason, it is necessary to prevent air **400** from being confined within the stopper **40**.

[0082] FIG. **11** is a plan view showing a corner of a liquid crystal display according to this embodiment. In FIG. **11**, the stopper **40** does not have an L shape, and has a first bar-shaped stopper **40**, which is formed along a short-side corner of the counter substrate **200**, and a second bar-shaped stopper **40**, which is formed along a long-side corner of the counter substrate **200**. That is, a corner of an L-shaped stopper **40** is cut out.

[0083] The bar-shaped stoppers **40** have the same shape as that of each side of the L-shaped stopper **40**. That is, each of the bar-shaped stoppers **40** is a length of 0.5 mm and a width of 10 μm . The height of the bar-shaped stopper **40** is 4 μm . This is because the bar-shaped stoppers **40** are formed by the same process as that of the columnar spacers **205** in the display region **10**.

[0084] In FIG. **11**, air **400** may be escaped through a gap **g** between the first bar-shaped stopper **40** and the second bar-shaped stopper **40** at the corner. Therefore, it is possible to avoid a phenomenon that air **400** is confined inside when the L-shaped stopper **40** is provided. In FIG. **11**, the gap **g** at the corner is small, and thus there is no case where the conductive paste **30** flows outward through the gap. This is because the conductive paste **30** has high viscosity and large surface tension.

[0085] FIG. **12** is a sectional view taken along the line C-C of FIG. **11**. In FIG. **12**, the gap **g** between the bar-shaped stoppers **40** in FIG. **11** is defined. Referring to FIG. **12**, the common wiring line **1011**, the gate insulating layer **102**, the inorganic passivation layer **107**, the organic passivation layer **108**, and the ITO layer formed on the TFT substrate **100**, and the counter electrode **204** formed on the counter substrate **200**, are not shown.

[0086] In FIG. **12**, the bar-shaped stoppers **40** are formed by the same process as the columnar spacer **205** in the display region **10**. That is, the bar-shaped stoppers are formed by applying acrylic resin on the entire surface of the counter substrate **200** and executing exposure and development. Therefore, the width of each of the bar-shaped stoppers **40** on the counter substrate **200** is larger than that on the TFT substrate **100**. As shown in FIG. **12**, the gap **g** between the bar-shaped stoppers **40** is a gap on the TFT substrate **100**.

[0087] The size of the gap **g** is an important factor. If the gap **g** is excessively large, the conductive paste **30** flows outward, and if the gap **g** is excessively small, internal air **400** may not

be sufficiently escaped. In order to prevent the conductive paste **30** from flowing outward, the gap **g** needs to be equal to or less than 100 μm , and preferably 50 μm . In order to prevent air **400** from being confined inside, the gap **g** needs to be equal to or more than 5 μm .

[0088] As described above, according to this embodiment, the bar-shaped stoppers **40** are provided at the corner, and thus it is possible to prevent air **400** from being confined inside. As a result, it is possible to reliably electrically connect the TFT substrate **100** and the counter substrate **200**.

Third Embodiment

[0089] FIGS. **13A** and **13B** show examples of a stopper **40** according to a third embodiment of the invention. In this embodiment, a stopper **40** is provided at a corner of the counter substrate **200**, and substantially has an L shape. However, the section is not uniform but uneven. Referring to FIG. **13A**, the stopper **40** has concave portions **41**. FIG. **13B** is a sectional view taken along the line D-D of FIG. **13A**. The concave portions **41** shown in FIGS. **13A** and **13B** have no special significance, but indicate that even if the stopper **40** has an uneven surface not a flat surface, it is possible to achieve the effect of the stopper **40** for stopping the conductive paste **30**.

[0090] FIG. **14** shows another example of the third embodiment. In FIG. **14**, it is assumed that a stopper **40** is provided at a corner of the counter substrate **200**. And, the stopper **40** shown in FIG. **14** substantially has an L shape. In FIG. **14**, each side of the L-shaped stopper **40** has a saw-toothed shape. With the saw-toothed sides, even though the viscosity of the conductive paste **30** is small, it is difficult for the conductive paste **30** to flow outward. Even though each side has a saw-toothed shape, the sectional width of the stopper **40** is 10 μm , and thus the stopper **40** occupies a negligible area in the frame portion. Like this embodiment, even though the planar shape of the stopper **40** is irregular, it is possible to achieve the effect of the stopper **40**.

[0091] In the foregoing embodiments, the TFT structure in the display region **10**, in which a-Si is used as the semiconductor layer **103** and the gate electrode **101** is provided below the semiconductor layer **103**, that is, a bottom gate-type TFT is used. However, the invention is not limited to the embodiments. For example, the invention may be applied to a TFT structure in the display region **10**, in which poly-Si is used for a semiconductor layer **103**, and a gate electrode **101** is provided above the semiconductor layer **103**, that is, a top gate-type TFT.

[0092] Although in the foregoing embodiments, the display region **10** of the liquid crystal display is for transmissive display in which light from the backlight is controlled, thereby forming an image, the invention is not limited thereto. For example, the invention may be applied to a case where the display region **10** is for reflective display in which external light is reflected, thereby forming an image. Of course, the invention may be applied to a transreflective display device that performs transmissive display and reflective display.

What is claimed is:

1. A liquid crystal display device comprising:
 - a TFT substrate that has a common wiring line for supplying a common voltage;
 - a counter substrate that has a counter electrode, to which the common voltage is supplied;
 - a sealant that bonds the TFT substrate and the counter substrate to each other; and

liquid crystal that is sealed between the TFT substrate, the counter substrate, and the sealant,

wherein the counter substrate has a display region and a frame region, and a width of the frame region is defined by a distance from a side determining an end of the display region to an end of the counter substrate, and the common wiring line of the TFT substrate and the counter electrode of the counter substrate are electrically connected by a conductive paste, the conductive paste is formed outside the sealant, and a stopper is formed on the counter substrate outside the conductive paste to prevent the conductive paste from flowing outward.

2. The liquid crystal display device according to claim 1, wherein the stopper is provided at two corners of the counter substrate.

3. The liquid crystal display device according to claim 1, wherein the stopper has an L shape.

4. The liquid crystal display device according to claim 1, wherein the sealant is made of epoxy resin, and the conductive paste is formed by conductive beads in epoxy resin.

5. The liquid crystal display device according to claim 1, wherein the width of the frame region is equal to or less than 1.5 mm.

6. A liquid crystal display device comprising:

a TFT substrate that has a common wiring line for supplying a common voltage;

a counter substrate that has a counter electrode, to which the common voltage is supplied;

a sealant that bonds the TFT substrate and the counter substrate to each other; and

liquid crystal that is sealed between the TFT substrate, the counter substrate, and the sealant,

wherein the counter substrate has a display region and a frame region, and a width of the frame region is defined by a distance from a side determining an end of the display region to an end of the counter substrate,

the counter substrate has long and short sides,

the common wiring line of the TFT substrate and the counter electrode of the counter substrate are electrically connected by a conductive paste, the conductive paste is formed outside the sealant, and a stopper is formed on the counter substrate outside the conductive paste to prevent the conductive paste from flowing outward, and

the stopper has a first stopper that is provided along a long-side corner of the counter substrate, and a second stopper that is provided along a short-side corner of the counter substrate, and a gap between the first stopper and the second stopper is in a range of 100 μm to 5 μm .

7. The liquid crystal display device according to claim 6, wherein the gap between the first stopper and the second stopper is in a range of 50 μm to 5 μm .

8. The liquid crystal display device according to claim 6, wherein the first stopper and the second stopper have a bar shape.

9. The liquid crystal display device according to claim 6, wherein the stopper is provided at two corners of the counter substrate to prevent the conductive paste from flowing outward.

10. The liquid crystal display device according to claim 6, wherein the width of the frame region is equal to or less than 1.5 mm.

11. A liquid crystal display device comprising:

a TFT substrate that has a common wiring line for supplying a common voltage;

a counter substrate that has a counter electrode, to which the common voltage is supplied;

a sealant that bonds the TFT substrate and the counter substrate to each other; and

liquid crystal that is sealed between the TFT substrate, the counter substrate, and the sealant,

wherein the counter substrate has a display region and a frame region, and a width of the frame region is defined by a distance from a side determining an end of the display region to an end of the counter substrate,

in the display region, a columnar spacer is formed on the counter substrate to define a gap between the TFT substrate and the counter substrate,

the common wiring line of the TFT substrate and the counter electrode of the counter substrate are electrically connected by a conductive paste, the conductive paste is formed outside the sealant, and a stopper is formed on the counter substrate outside the conductive paste to prevent the conductive paste from flowing outward, and the stopper and the columnar spacer are made of the same material.

12. The liquid crystal display device according to claim 11, wherein the stopper and the columnar spacer are formed by the same process.

13. The liquid crystal display device according to claim 11, wherein the stopper and the columnar spacer have the same height.

14. The liquid crystal display device according to claim 11, wherein the width of the frame region is equal to or less than 1.5 mm.

* * * * *

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摘要(译)

公开了一种液晶显示装置，其能够防止用于连接TFT基板的公共配线和相对基板的对电极的导电膏向外流动。密封剂形成在液晶显示装置的显示区域外。用于连接TFT基板的公共配线和相对基板的对电极的导电膏设置在密封剂外部的液晶显示装置的拐角处。在对向基板上形成L形止动件，以防止导电膏向外流动。利用止动件，即使框架的宽度等于或小于1.5mm，也可以防止导电膏向外流动。

